ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannoc aternational and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with lowe	er level	parts, the	declaratio	n encomp		er level mat	erials for	which th	eitem is an assembly e manufacturer has eclaration.	
1752-2 1.1	IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x								Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa						
Supplier Information															
Company Name *		Company Unique ID		Unique ID Au	uthority	Resp	onse Date	e *	R	esponse Doc	ument ID				
Mindspeed Technologies Inc. N/A				N/A		2012-	09-05								
Contact Name * Title - Contact				Phone - Contact *			l - Contac	t *							
Cynthia Ong Program Manager				949-579-5515			ia.ong@r	nindspe	ed.com	Duplicate	Contact	-> Autho	rized Re	presentative	
Authorized Representative * Title - Representative			9	Phone - Representative *			Email - Representative *			Supplier Comments or URL for Additional Information					
Amy Teng		Quality Engineer		604-6328114	Į.	amy.	eng@mir	ndspeed.	com						
Requester Item Number N		Mfr Item Number		Mfr Item Name	Effective Date Version			n Manufacturing Site		Weight *	UC	M	Unit Type		
M02142G-13	02142G-13 M02142G-13			3QFN 16			10-07-23 A Unise		Unisem,	Malaysia	22.922	mg		EACH	
Alternate Recommendation				NA			Alternate Iter			em Comments NA					
Manufacturing Proces	ss In	formation													
Terminal Plating / Grid Array	Materi	al	Terminal Ba	ase Alloy	J-STD-020 MSL I	Rating	Peak Prod	ess Body	Temperat	ure Max Time	at Peak Tem	perature	Number of	of Reflow Cycles	
Sn Cu Allo			Cu Alloy	y 2							40 seconds 3			•	
Comments															
N/A															

Save the fields in this form to a file	Export Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent changes	Lock Supplier Fields
RoHS Material Cor	mposition Declaratio	n				Declaration Type *	Simplified
	Definition: Quantity lim rominated Diphenyl Ethe					alent Chromium, Polybromii admium	nated Biphenyls (PBB),
nat Supplier completes this for upplier may have relied on infu upplier agrees that, at a minir ritten agreement with respect	rm. Supplier acknowledges that C formation provided by others in co mum, its suppliers have provided	ompany will rely on this certificated by the certificated by the sound that Suppersifications regarding their conditions of that agreement,	ation in determining the compli oplier may not have independent outributions to the part, and those	ance of its products with Euro ently verified such information se certifications are at least as	pean Union member state laws t . However, in situations where So comprehensive as the certificati	is true and correct to the best of its kethat implement the RoHS Directive. Coupplier has not independently verified ion in this paragraph. If the Company e sole and exclusive source of the Su	company acknowledges that I information provided by others, and the Supplier enter into a
RoHS Declaration *	1 - Item(s) does not contain Ro	HS restricted substances per	the definition above			Supplier Acceptance * Acce	epted
xemptions: If the declar bove and choose all app		RoHS restricted substan	ces per the definition ab	ove except for defined	RoHS exemptions, then so	elect the corresponding respo	nse in the RoHS Declaration
Declaration Signa	ture						
nstructions: Comple	ete all of the required fie	lds on all pages of this	form. Select the "Ac	cepted" on the Suppl	er Acceptance drop-dov	wn. This will display the sig	gnature area. Digitally sign

the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous Material	Wajaht	Unit of		Ι.	Laval	Substance Catemany			Cultotonos	CAC		34/	Unit of Measure	Tolerance		e DDM
	Name			Weight	Measure		ľ	Level	Substance Category			Substance	CAS Exempt Wo	weight	-		+	PPM	
+1 -1	M02142G-13	+M -M	Leadframe	9.2468	mg	+C -	C	;	GROUP-C	+S	-S	Cu	7440-50-8		8.9638	mg			969,39
		_				+C -	c c	;	GROUP-C	+S	-S	Fe	7439-89-6		0.2161	mg			23,370
						+C -	c c	;	GROUP-C	+S	-S	Zn	7440-66-6		0.011	mg			1,189.6
						+C -	c c	;	GROUP-C	+S	-S	P	7723-14-0		0.0028	mg			302.80
						+C -	C c	;	GROUP-C	+S	-s	Ag	7440-22-4		0.0531	mg			5,742.5
		+M -M	Wire	0.1295	mg	+C -	C c	;	GROUP-C	+S	-s	Gold	7440-57-5		0.1295	mg			999,99
		+M -M	Mold compound	12.2435	mg	+C -	C c	;	GROUP-C	+S	-s	Phenol Resin	Trade secret		0.4897	mg			39,996
			•	•		+C -	C c	;	GROUP-C	+S	-s	Carbon Black	1333-86-4		0.0367	mg			2,997.5
						+C -	C c	;	GROUP-C	+S	-s	Epoxy Resin	Trade secret		0.4897	mg			39,996
						+C -	C c	;	GROUP-C	+S	-s	Silica Fused	60676-86-0		11.2274	mg			917,00
		+M -M	Die	0.9953	mg	+C -	C c	;	GROUP-C	+S	-s	Silicon Die	7440-21-3		0.9953	mg			999,99
		+M -M	Die Attach	0.1558	mg	+C -	C	;	GROUP-C	+S	-s	Silver	7440-22-4		0.1168	mg			749,67
						+C -	C	;	GROUP-C	+S	-s	1,1 -(1,3-Phenylene)bis-	Proprietary		0.0078	mg			50,064
						+C -	C	:	GROUP-C	+S	-s	Methacrylate	Proprietary		0.0312	mg			200,25
		+M -M	Tin Plating	0.1511	mg	+C -	C	;	GROUP-C	+S	-s	Sn	7440-31-5		0.1511	mg			999,99